



BAV70HDW

Features

- Fast Switching Speed
- Low Capacitance
- Low Leakage Current
- Two "BAV70" Circuits in One Package
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen- and Antimony-Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Qsuffix) part. A listing can be found at https://www.diodes.com/products/automotive/automotiveproducts/.
- This part is qualified to JEDEC standards (as references in AEC-Q) for High-Reliability.
 - https://www.diodes.com/quality/product-definitions/
- An Automotive-Compliant Part is Available Under Separate Datasheet (<u>BAV70HDWQ</u>)

SOT363



A, A, C Top View

Internal Schematic

Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
BAV70HDW-7	Standard	SOT363	3,000/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

Date Code Key				KJB Y		YM = Da Y = Year	roduct Type ate Code M r ex: H = 20 th ex: 9 = \$	arking)20				
Year	2015			2020		2021	2022		2023	2024		2025
Code	С			Н		I	J		К	L		М
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

Mechanical Data

- Case: SOT363
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0

SURFACE MOUNT SWITCHING DIODE ARRAY

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Lead-Frame (Lead-Free Plating).
 Solderable per MIL-STD-202, Method 208 ⁽²⁾
- Orientation: See Diagram
- Weight: 0.006 grams (Approximate)



Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	100	V
RMS Reverse Voltage		V _{R(RMS)}	71	V
Forward Continuous Current (Note 5)		I _{FM}	250	mA
Average Rectified Output Current (Note 5)		lo	125	mA
Repetitive Peak Forward Current		IFRM	450	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0µs @ t = 1.0ms @ t = 1.0s	I _{FSM}	4 1 0.5	A

Thermal Characteristics

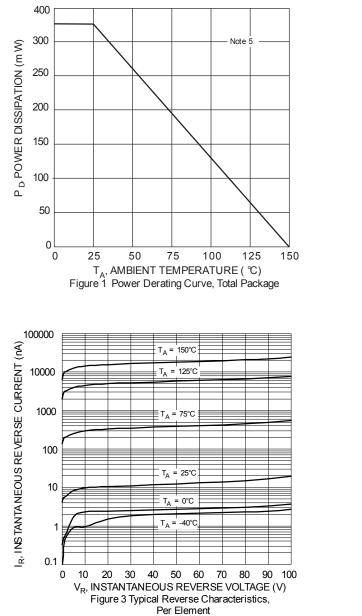
Characteristic	Symbol	Value	Unit
Typical Power Dissipation (Note 5)	PD	350	mW
Typical Thermal Resistance, Junction to Ambient Air (Note 5)	R _{0JA}	357	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

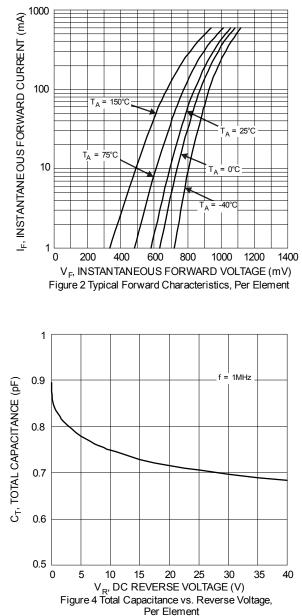
Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	V _{(BR)R}	100	_	V	I _R = 20μA
Forward Voltage	V _F	_	0.715 0.855 1.0 1.25	V	I _F = 1.0mA I _F = 10mA I _F = 50mA I _F = 150mA
Reverse Current (Note 6)	I _R	_	0.5 100 30 30	μΑ μΑ	V _R = 80V V _R = 80V, T _J = +150°C V _R = 25V, T _J = +150°C V _R = 25V
Total Capacitance	CT		1.5	pF	V _R = 0, f = 1.0MHz
Reverse Recovery Time	t _{RR}	_	4.0	ns	I _F = I _R = 10mA, I _{RR} = 0.1 x I _R , R _L = 100Ω
Forward Recovery Voltage	V _{FR}	_	1.75	V	I _F = 10mA, t _R = 20ns

Notes: 5. Part is mounted on a 1.5"x1.5" FR-4 substrate PC board, with 1" X 1" 2oz Cu pad. 6. Short duration pulse test used to minimize self-heating effect.



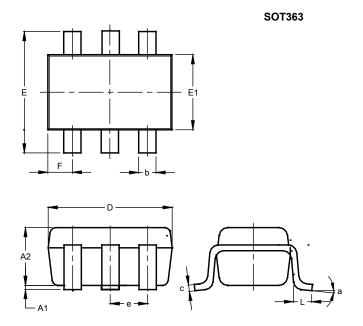






Package Outline Dimensions

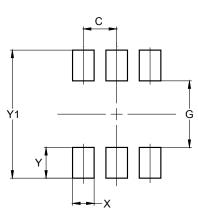
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT363						
Dim	Min	Max	Тур			
A1	0.00	0.10	0.05			
A2	0.90	1.00	0.95			
b	0.10	0.30	0.25			
С	0.10	0.22	0.11			
D	1.80	2.20	2.15			
Е	2.00	2.20	2.10			
E1	1.15	1.35	1.30			
е	C	.650 E	SC			
F	0.40	0.45	0.425			
L	0.25	0.40	0.30			
а	0°	8°				
All I	All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	0.650
G	1.300
X	0.420
Y	0.600
Y1	2.500

SOT363



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